L Number	Hits	Search Text	DB	Time stamp
-	53415	(chemicaladj mechanical adj polishing) or CMP	USPAT;	2004/09/22 11:29
		, , , , , , , , , , , , , , , , , , , ,	US-PGPUB;	
			EPO; JPO;	
1			DERWENT,	
			IBM TDB	
1.	771	((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:50
1		((diamond adj like adj carbon) or DLC)	US-PGPUB;	
		((	EPO; JPO;	
1	·		DERWENT;	
			IBM TDB	
-	2	(((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:50
1	_	((diamond adj like adj carbon) or DLC)) and (plurality adj	US-PGPUB;	
		array)	EPO; JPO;	
1			DERWENT;	
			IBM_TDB	
1_	205	(((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:50
	200	((diamond adj like adj carbon) or DLC)) and array	US-PGPUB;	200 1/00/22 10:00
1			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	213	((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 11:31
1	2.0	(((diamond adj like adj carbon) or DLC) with (upper surface))	US-PGPUB;	200 1700/22 11:01
		(((a.a	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
_	57	(((chemicaladj mechanical adj polishing) or CMP) and	USPAT;	2004/09/22 10:52
-	0,	(((diamond adj like adj carbon) or DLC) with (upper surface)))	US-PGPUB;	2004/03/22 10.02
		and ((((chemicaladj mechanical adj polishing) or CMP) and	EPO; JPO;	
		((diamond adj like adj carbon) or DLC)) and array)	DERWENT;	
		(diamond adjinke adjidarbon) of DEO)) and array)	IBM_TDB	
_	524541	(chemicaladj mechanical adj polishing) or CMP or etch\$4	USPAT;	2004/09/22 11:30
-	024041	(one-micalady mechanical ady polishing) of own of elong-	US-PGPUB;	2004/03/22 11.30
		·	EPO; JPO;	
			DERWENT;	
,			IBM_TDB	
_	771	((chemicaladj mechanical adj polishing) or CMP or etch\$4)	USPAT;	2004/09/22 11:30
	,	and (((chemicalad) mechanical adj polishing) or CMP) and	US-PGPUB;	200 1100/22 11:00
		((diamond adj like adj carbon) or DLC))	EPO; JPO;	
		((alamona daj mio daj barbon) or 520))	DERWENT:	
			IBM TDB	
_	213	(((chemicaladj mechanical adj polishing) or CMP or etch\$4)	USPAT;	2004/09/22 15:06
		and (((chemicaladj mechanical adj polishing) or CMP) and	US-PGPUB;	
		((diamond adj like adj carbon) or DLC))) and (((diamond adj	EPO; JPO;	
		like adj carbon) or DLC) with (upper surface))	DERWENT;	
		, (255. 22	IBM_TDB	
-	255	438/105,7,8,16.ccls. and ((chemicaladj mechanical adj	USPAT;	2004/09/22 15:18
		polishing) or CMP)	US-PGPUB;	
		, , ,	EPO; JPO;	
		,	DERWENT;	
			IBM_TDB	
-	5	438/105,7,8,16.ccls. and ((chemicaladj mechanical adj	USPAT;	2004/09/22 15:46
		polishing) or CMP) and ((diamond adj like adj carbon) or	US-PGPUB;	
		DLC)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
-	23	438/105,7,8,16.ccls. and ((diamond adj like adj carbon) or	USPAT;	2004/09/22 15:31
		DLC)	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	

-	5	438/105,7,8,16.ccls. and ((chemical adj mechanical adj	USPAT;	2004/09/22 15:47
		polishing) or CMP) and ((diamond adj like adj carbon) or	US-PGPUB;	
		DLC)	EPO; JPO;	
			DERWENT;	
			IBM_TDB	